

Description

The AP60N04DF uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a

Battery protection or in other Switching application.



V_{DS} = 40V I_D =60 A

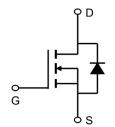
 $R_{DS(ON)}$ < 15.5m Ω @ V_{GS} =10V

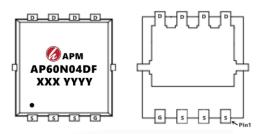
Application

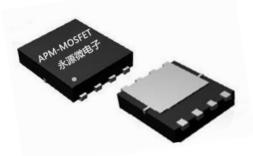
Battery protection

Load switch

Uninterruptible power supply







Package Marking and Ordering Information

ackage marking and Ordering information				
Product ID	Pack	Marking	Qty(PCS)	
AP60N04DF	PDFN3*3-8L	AP60N04DF XXX YYYY	5000	

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	40	V
V _G s	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	60	А
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	26	Α
I _D @T _A =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	10	А
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ 10V ¹	8	А
Ірм	Pulsed Drain Current ²	100	А
EAS	Single Pulse Avalanche Energy ³	31	mJ
las	Avalanche Current	25	Α
P _D @T _C =25°C	Total Power Dissipation ⁴	34.7	W
P _D @T _A =25°C	Total Power Dissipation ⁴	2	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
$R_{\theta JA}$	Thermal Resistance Junction-ambient (Steady State)¹	62	°C/W
Rejc	Thermal Resistance Junction-Case ¹	3.6	°C/W





Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	40			V
2BV DSS/2TJ	BVDSS Temperature Coefficient	Reference to 25°C , I _D =1mA		0.034		V/°C
		V _{GS} =10V , I _D =20A		12.5	15.5	
RDS(ON)	Static Drain-Source On-Resistance ²	V _{GS} =4.5V , I _D =10A		14.5	20	mΩ
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250uA$	1.0	1.5	2.5	V
₹VGS(th)	V _{GS(th)} Temperature Coefficient			-5.64		mV/°C
		V _{DS} =32V , V _{GS} =0V , T _J =25°C			1	_
IDSS	Drain-Source Leakage Current	V _{DS} =32V , V _{GS} =0V , T _J =55°C			5	uA
Igss	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =20A		36		S
R _g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		2.1	4.2	Ω
Qg	Total Gate Charge (4.5V)			10.7		
Qgs	Gate-Source Charge	V _{DS} =20V , V _{GS} =4.5V , I _D =12A		3.3		nC
Qgd	Gate-Drain Charge			4.2		
T _{d(on)}	Turn-On Delay Time			8.6		
Tr	Rise Time	V _{DD} =12V , V _{GS} =10V ,		3.4		
Td(off)	Turn-Off Delay Time	R _G =3.3		25		ns
Tf	Fall Time			2.2		
Ciss	Input Capacitance			1314		
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		120		pF
Crss	Reverse Transfer Capacitance			88		
ls	Continuous Source Current ^{1,5}				42	Α
lsм	Pulsed Source Current ^{2,5}	V _G =V _D =0V , Force Current			100	Α
Vsp	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1.2	V

Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leqq 300 \text{us}$, duty cycle $\leqq 2\%$
- 3.The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V,L=0.1mH, I_{AS} =25A
- 4.The power dissipation is limited by 150°C junction temperature
- 5 . The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

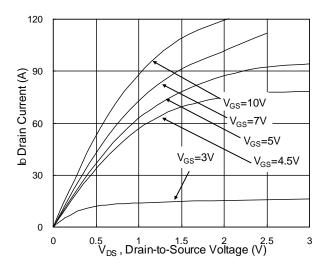


Fig.1 Typical Output Characteristics

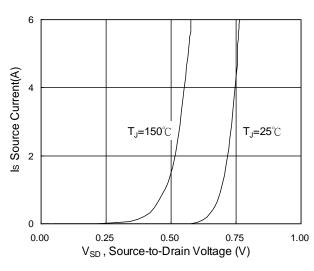


Fig.3 Forward Characteristics of Reverse

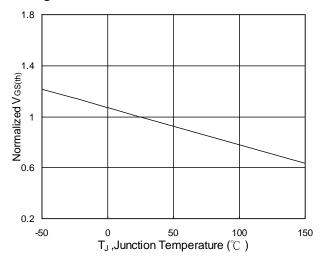


Fig.5 V_{GS(th)} vs. T_J

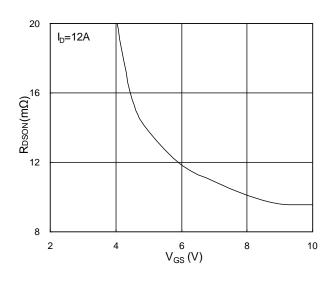


Fig.2 On-Resistance vs. G-S Voltage

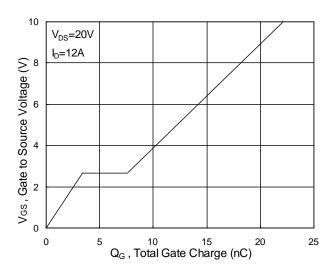


Fig.4 Gate-Charge Characteristics

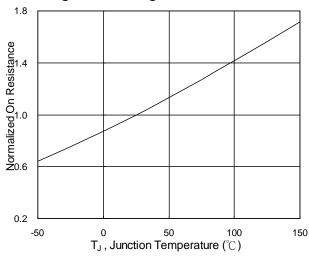
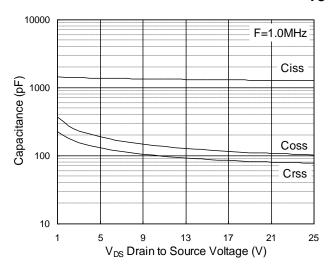


Fig.6 Normalized R_{DSON} vs. T_J







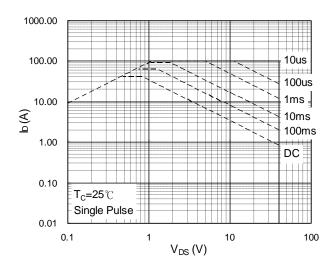


Fig.7 Capacitance

Fig.8 Safe Operating Area

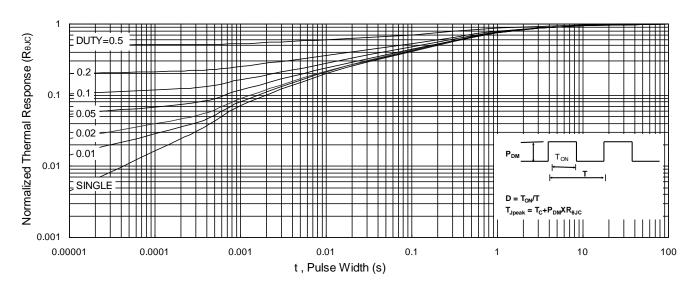


Fig.9 Normalized Maximum Transient Thermal Impedance

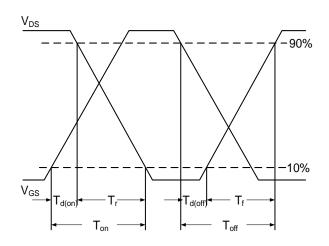


Fig.10 Switching Time Waveform

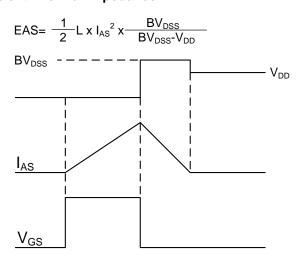
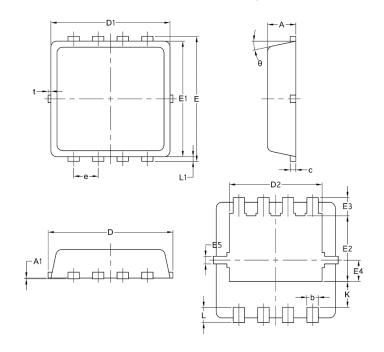


Fig.11 Unclamped Inductive Switching Waveform



40V N-Channel Enhancement Mode MOSFET Package Mechanical Data-DFN3*3-8L-JQ Single



	Common			
Symbol	mm			
	Mim	Nom	Max	
А	0.70	0.75	0.85	
A1	/	/	0.05	
b	0.20	0.30	0.40	
С	0.10	0.152	0.25	
D	3.15	3.30	3.45	
D1	3.00	3.15	3.25	
D2	2.29	2.45	2.65	
E	3.15	3.30	3.45	
E1	2.90	3.05	3.20	
E2	1.54	1.74	1.94	
E3	0.28	0.48	0.65	
E4	0.37	0.57	0.77	
E5	0.10	0.20	0.30	
е	0.60	0.65	0.70	
К	0.59	0.69	0.89	
L	0.30	0.40	0.50	
L1	0.06	0.125	0.20	
t	0	0.075	0.13	
Ф	10	12	14	





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AP60N04DF

40V N-Channel Enhancement Mode MOSFET

Edition	Date	Change
Rve1.0	2019/4/31	Initial release

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DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
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BXP2N65D BXT1150N10J BXT1700P06M TSM60NB380CP ROG RQ7L055BGTCR DMNH15H110SK3-13 SLF10N65ABV2
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